Preliminary



• No Matching Network Required for 50 Ω Operation

- Surface-mount 3.0 x 3.0 mm Package
- Complies with Directive 2002/95/EC (RoHS)

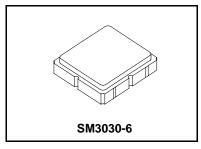


Absolute Maximum Ratings

Rating	Value	Units
Input Power Level	20	dBm
DC Voltage on any Non-ground Terminal	0	V
Operating Temperature Range	-30 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Solder Reflow Temperature, 10 seconds, 5 cycles maximum	260	°C

SF2207E

800 MHz **SAW Filter**



Electrical Characteristics

Characteristic	Sym	Notes	Min	Тур	Max	Units	
Center Frequency	f _C			800.0		MHz	
Insertion Loss, 790.0 to 810.0 MHz	IL			2.3	3.0	٩D	
Amplitude Ripple, 790.0 to 810.0 MHz				1.4	2.0	dB	
Input/Output VSWR, 790.0 to 810.0 MHz				2.1:1	2.5:1		
Attenuation, 0 dB Reference:							
0.3 to 760.0 MHz			25	30		dB	
832.0 to 852.0 MHz			30	37		ub ub	
852.0 to 900.0 MHz			25	32			
Source Impedance	Z _S			50		0	
Load Impedance	Z _L			50		Ω	

Case Style	SM3030-6 3.0 x 3.0 mm Nominal Footprint	
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	941, YWWS	
Standard Reel Quantity Reel Size 7 Inch	500 Pieces/Reel	
Reel Size 13 Inch	3000 Pieces/Reel	

Electrical Connections

Connection	Terminals
Input	2
Output	5
Case Ground	All others

CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

Notes:

Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer. 1.

Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.

Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external

impedance matching design. See Application Note No. 42 for details.

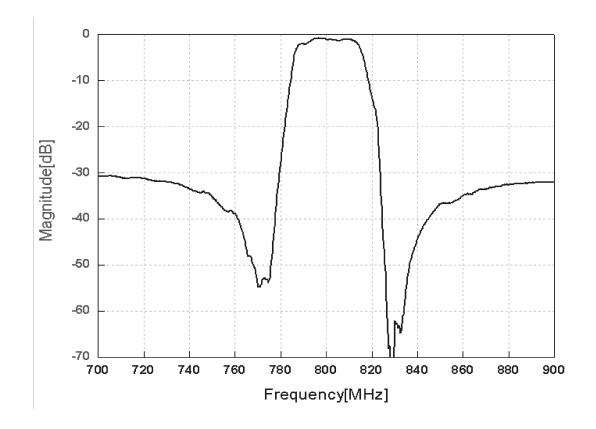
"LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."

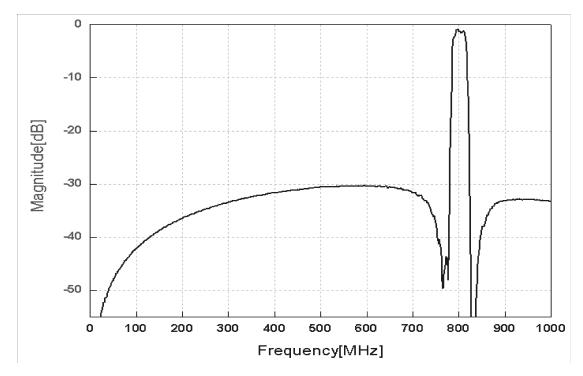
The design, manufacturing process, and specifications of this filter are subject to change.

Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 5. 6. 2, so that the filter must always be installed in one direction per the circuit design.

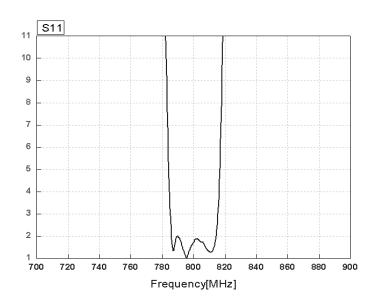
US and international patents may apply.
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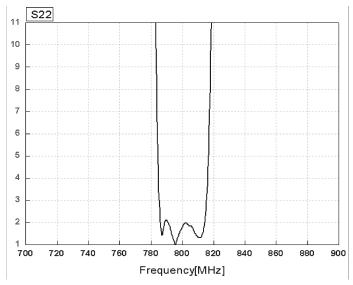
Filter Frequency Response Plots

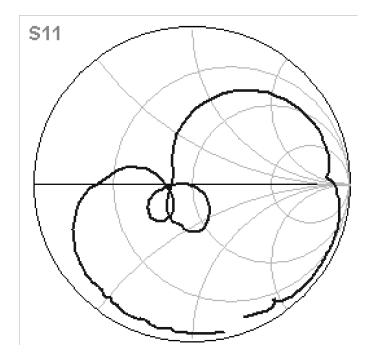


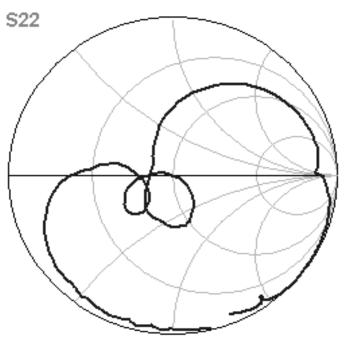


Filter VSWR and Smith Chart Plots



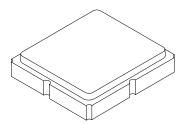


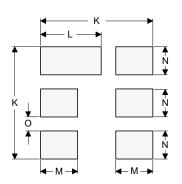




SM3030-6 Case

6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint





PCB Footprint Top View

Case and PCB Footprint Dimensions

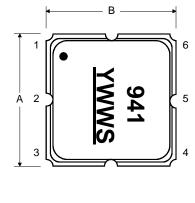
Dimension	mm			Inches		
Difficusion	Min	Nom	Max	Min	Nom	Max
Α	2.87	3.00	3.13	0.113	0.118	0.123
В	2.87	3.00	3.13	0.113	0.118	0.123
С	1.12	1.25	1.38	0.044	0.049	0.054
D	0.77	0.90	1.03	0.030	0.035	0.040
E	2.67	2.80	2.93	0.105	0.110	0.115
F	1.47	1.60	1.73	0.058	0.063	0.068
G	0.72	0.85	0.98	0.028	0.033	0.038
Н	1.37	1.50	1.63	0.054	0.059	0.064
I	0.47	0.60	0.73	0.019	0.024	0.029
J	1.17	1.30	1.43	0.046	0.051	0.056
K		3.20			0.126	
L		1.70			0.067	
М		1.05			0.041	
N		0.81			0.032	
0		0.38			0.015	

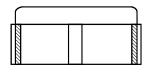
Case Materials

← D →

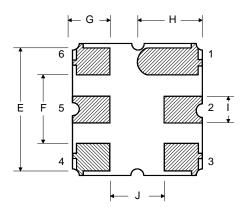
Materials				
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel			
Lid Plating	2.0 to 3.0 µm Nickel			
Body	Al ₂ O ₃ Ceramic			
Pb Free				

Top View

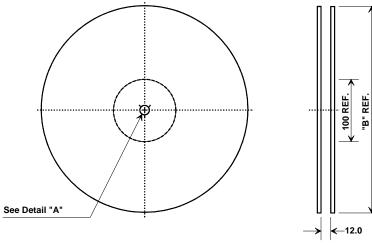




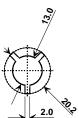
Bottom View



Tape and Reel Specifications



	"B"	Quantity Per Reel	
Inches	millimeters		
7	178	500	
13	330	3000	



COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions					
Ao	3.35 mm				
Во	3.35 mm				
Ko	1.40 mm				
Pitch	8.0 mm				
W	12.0 mm				

